

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6998321

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JAEHYEONG LEE	07/27/2021
HYEOKSHIN KWON	07/27/2021
JAEHO SHIN	07/27/2021
TAEHWAN JANG	07/27/2021
INSU JEON	07/27/2021
RECEIVING PARTY DATA	
Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU, GYEONGGI-DO
City:	SUWON-SI
State/Country:	KOREA, REPUBLIC OF
Postal Code:	16677
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17515055
CORRESPONDENCE DATA	
Fax Number:	(202)293-7860
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	2022937060
Email:	wmulhall@sughrue.com, sughrue@sughrue.com
Correspondent Name:	SUGHRUE MION, PLLC
Address Line 1:	2000 PENNSYLVANIA AVENUE NW
Address Line 2:	SUITE 900
Address Line 4:	WASHINGTON, D.C. 20006
ATTORNEY DOCKET NUMBER:	Q264761
NAME OF SUBMITTER:	WILLIAM MULHALL
SIGNATURE:	/William Mulhall/
DATE SIGNED:	10/29/2021
This document serves as an Oath/Declaration (37 CFR 1.63).	

Total Attachments: 2

source=Q264761ExecutedAssignmentwithDeclarationTOBEFILED#page1.tif

source=Q264761ExecutedAssignmentwithDeclarationTOBEFILED#page2.tif

ASSIGNMENT WITH DECLARATION FOR UTILITY OR DESIGN PATENT APPLICATION (37 CFR 1.63)

Whereas, We, the undersigned inventors hereinafter called assignors, have invented certain improvements described in the application identified below; and

Whereas, SAMSUNG ELECTRONICS CO., LTD. of 129, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16677, Republic of Korea, (assignee), desires to acquire the entire right, title, and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged,

We, the above named assignors, hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted thereon, and all reissues thereof, and all countries foreign thereto, including rights of priority under the International Convention of Paris (1883) as amended, including the right to claim priority under 35 USC 119 and the right to sue for past damages, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we hereby agree that the assignee may apply for foreign Letters Patent on the invention and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States and foreign applications when called upon to do so by the assignee.

(Legalization not required for recording but is prima facie evidence of execution under 35 USC 261)

As the below named inventor, I hereby declare that:

This assignment with declaration is ☒ The attached application, or directed to:
☐ United States Application or PCT International Application Number _____ filed on _____
(Confirmation No. _____).

The application is entitled:

SUPERCONDUCTING QUBIT MEMORY OF QUANTUM COMPUTER

The above identified application was made or was authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I have reviewed and understand the contents of the application for which this assignment with declaration is being submitted.

I am aware of the duty to disclose to the Office all information known to me to be material to patentability as defined in 37 CFR 1.56.

I hereby acknowledge that any willful false statement made in this assignment with declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

NAME OF SOLE OR FIRST INVENTOR:	
Given Name (first and middle [if any])	Jaehyeong
Family Name or Surname	Lee
Inventor's signature	Date 7/27/2021
Residence: Gwacheon-si, Republic of Korea	
Mailing Address: c/o Samsung Advanced Institute of Technology, 130, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16678, Republic of Korea	
NAME OF SECOND INVENTOR:	
Given Name (first and middle [if any])	Hyeokshin
Family Name or Surname	Kwon
Inventor's signature	Date 7/27/2021
Residence: Seoul, Republic of Korea	
Mailing Address: c/o Samsung Advanced Institute of Technology, 130, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16678, Republic of Korea	
NAME OF THIRD INVENTOR:	
Given Name (first and middle [if any])	Jacho
Family Name or Surname	Shin
Inventor's signature	Date 7/27/2021
Residence: Cheonan-si, Republic of Korea	
Mailing Address: c/o Samsung Advanced Institute of Technology, 130, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16678, Republic of Korea	
NAME OF FOURTH INVENTOR:	
Given Name (first and middle [if any])	Tachwan
Family Name or Surname	Jang
Inventor's signature	Date 7/27/2021
Residence: Suwon-si, Republic of Korea	
Mailing Address: c/o Samsung Advanced Institute of Technology, 130, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16678, Republic of Korea	
NAME OF FIFTH INVENTOR:	
Given Name (first and middle [if any])	Insu
Family Name or Surname	Jeon
Inventor's signature	Date 7/27/2021
Residence: Seoul, Republic of Korea	
Mailing Address: c/o Samsung Advanced Institute of Technology, 130, Samsung-ro, Yeongtong-gu, Suwon-si, Gyeonggi-do, 16678, Republic of Korea	